



U74AHC595

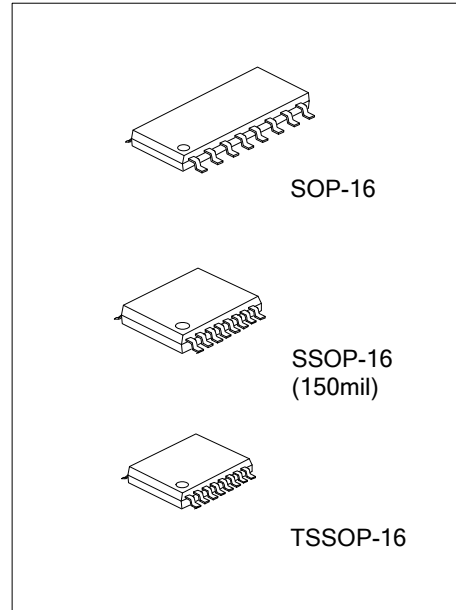
CMOS IC

8-BIT SHIFT REGISTER WITH 3-STATE OUTPUT REGISTERS

DESCRIPTION

The UTC **74AHC595** contains an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. The storage register has parallel 3-state outputs. Separate clocks are provided for both the shift and storage registers. The shift register has a direct overriding clear (\overline{SRCLR}) input, serial (SER) input, and a serial output for cascading. When the output-enable (\overline{OE}) input is high, all outputs, except Q_H , are in the high-impedance state.

Both the shift-register clock (SRCLK) and storage-register clock (RCLK) are positive-edge triggered. If both clocks are connected together the shift register always is one clock pulse ahead of the storage register.

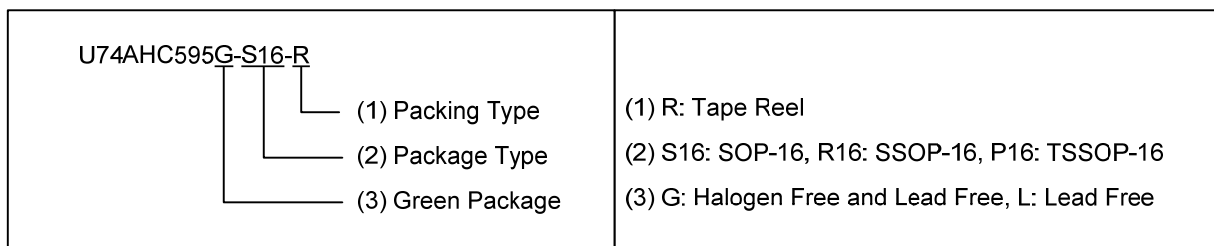


FEATURES

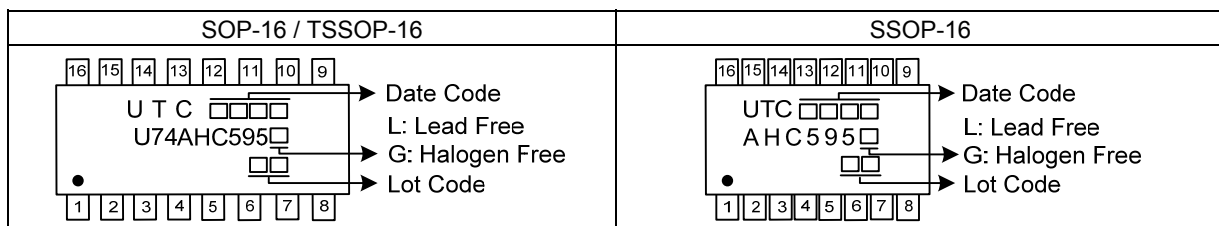
- * Operation Voltage Range: 2 ~ 5.5V
- * Shift Register Has Direct Clear
- * 8-bit Serial-In, Parallel-Out Shift

ORDERING INFORMATION

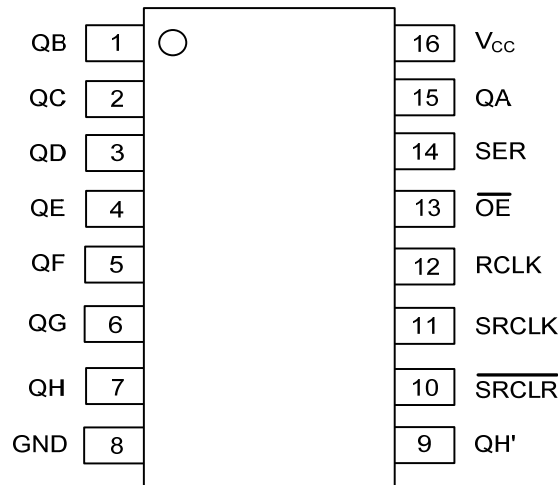
Ordering Number		Package	Packing
Lead Free	Halogen Free		
U74AHC595L-S16-R	U74AHC595G-S16-R	SOP-16	Tape Reel
U74AHC595L-R16-R	U74AHC595G-R16-R	SSOP-16	Tape Reel
U74AHC595L-P16-R	U74AHC595G-P16-R	TSSOP-16	Tape Reel



MARKING



■ PIN CONFIGURATION

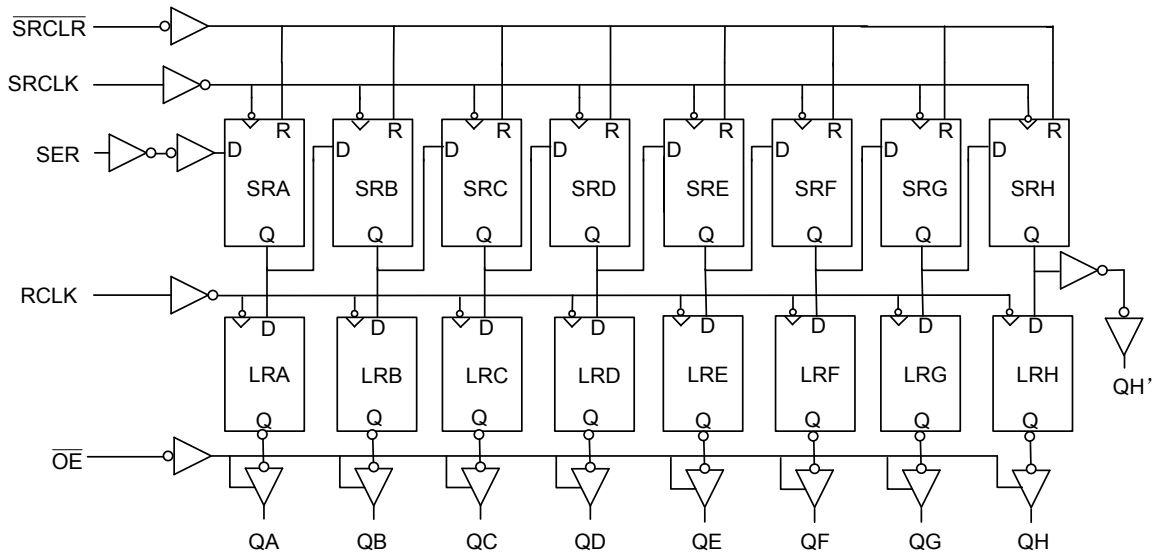


■ FUNCTION TABLE

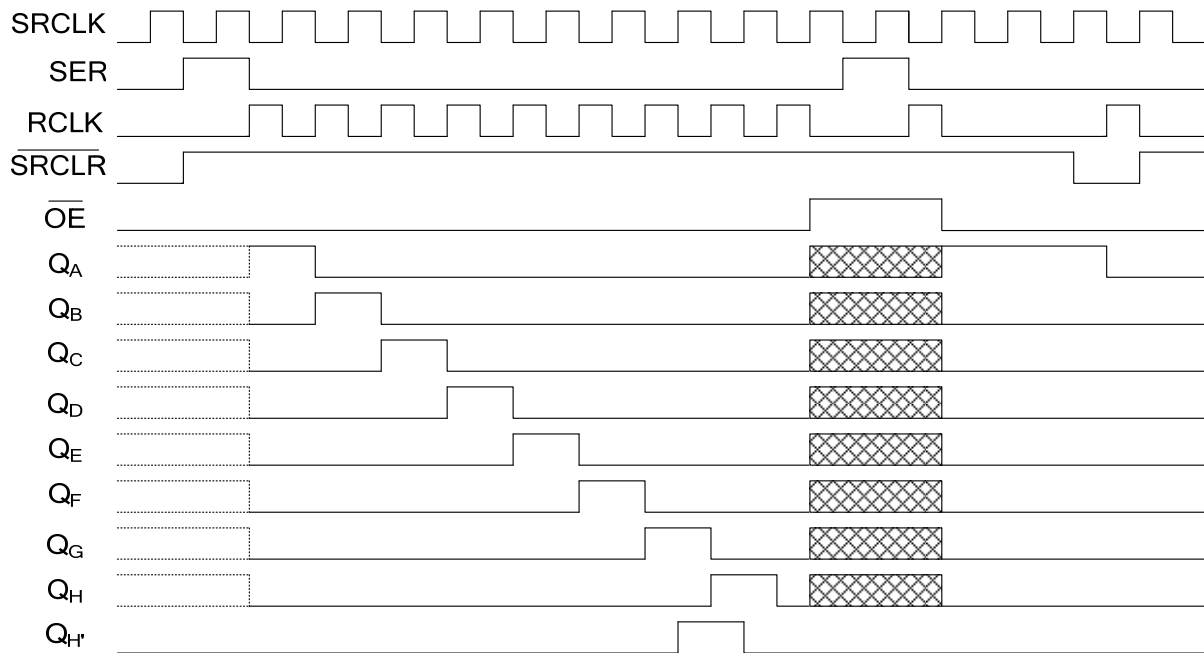
FUNCTION	INPUTS					OUTPUTS	
	SRCLK	RCLK	\overline{OE}	\overline{SRCLR}	SER	QH'	Qn
A Low-Level on \overline{SRCLR} only affects the shift registers.	X	X	L	L	X	L	NC
Empty shift register loaded into storage register.	X	↑	L	L	X	L	L
Shift register clear. Parallel outputs in high-impedance OFF-state	X	X	H	L	X	L	Z
Logic high level shifted into the first shift register. Contents of all shift register stages shifted through, e.g. previous state of stage G(internal QG') appears on the serial output(QH').	↑	X	L	H	H	QG'	NC
Contents of shift register stages (internal Qn') are transferred to the storage register and parallel output stages.	X	↑	L	H	X	NC	Qn'
Contents of shift register shifted through. Previous contents of the shift register is transferred to the storage register and the parallel output stages.	↑	↑	L	H	X	QG'	Qn'


Note:H : HIGH voltage level.
 L : LOW voltage level.
 X : Don't care.
 Z : High impedance OFF-state.
 NC: No change.
 ↑ : Low-to-High transition.
 ↓ : High-to-Low transition.

■ LOGIC DIAGRAM (POSITIVE LOGIC)



■ TIMING DIAGRAM



Note:  Implies that the outputs is in 3-State mode.

■ ABSOLUTE MAXIMUM RATING (unless otherwise specified)(Note 2)

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage	V_{CC}	-0.5 ~ 7.0	V
Input Voltage	V_{IN}	-0.5 ~ 7.0	V
Output Voltage(active mode)	V_{OUT}	-0.5 ~ $V_{CC}+0.5$	V
Input Clamp Current ($V_{IN}<0$)	I_{IK}	-20	mA
Output Clamp Current ($V_{OUT}<0$)	I_{OK}	±20	mA
Output Current	I_{OUT}	±25	mA
V_{CC} or GND Current	I_{CC}	±75	mA
Storage Temperature	T_{STG}	-65 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	73	°C/W
		90	
		108	

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Supply Voltage	V_{CC}	2		5.5	V
Input Voltage	V_{IN}	0		5.5	V
Output Voltage	V_{OUT}	0		V_{CC}	V
Input Transition Rise or Fall Rate	$\Delta t/\Delta v$			100	ns/V
				20	
Operating Temperature	T_A	-40		+125	°C

■ ELECTRICAL CHARACTERISTICS (Unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	T _A =25°C			T _A =-40°C~+125°C			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
HIGH-level input voltage	V _{IH}	V _{CC} =2V	1.5			1.5			V
		V _{CC} =3V	2.1			2.1			
		V _{CC} =5.5V	3.85			3.85			
LOW-level output voltage	V _{IL}	V _{CC} =2V			0.5			0.5	V
		V _{CC} =3V			0.9			0.9	
		V _{CC} =5.5V			1.65			1.65	
High-Level Output Voltage	V _{OH}	V _{CC} =2V, I _{OH} =-50μA	1.9	2		1.9			V
		V _{CC} =3V, I _{OH} =-50μA	2.9	3		2.9			
		V _{CC} =4.5V, I _{OH} =-50μA	4.4	4.5		4.4			
		V _{CC} =3V, I _{OH} =-4mA	2.58			2.40			
		V _{CC} =4.5V, I _{OH} =-8mA	3.94			3.70			
Low-Level Output Voltage	V _{OL}	V _{CC} =2V, I _{OL} =50μA			0.1			0.1	V
		V _{CC} =3V, I _{OL} =50μA			0.1			0.1	
		V _{CC} =4.5V, I _{OL} =50μA			0.1			0.1	
		V _{CC} =3V, I _{OL} =4mA			0.36			0.55	
		V _{CC} =4.5V, I _{OL} =8mA			0.36			0.55	
Input Leakage Current	I _{I(LEAK)}	V _{CC} =0 ~ 5.5V, I _{IN} =5.5V or GND			±0.1			±2	μA
Output Off-state Current	I _{OZ}	V _{CC} =5.5V, V _{IN} =V _{CC} or GND, V _{OUT} =V _{CC} or GND, \overline{OE} =V _{IH} or V _{IL}			±0.25			±10	μA
Quiescent Supply Current	I _{CC}	V _{CC} =5.5V, V _{IN} =GND or V _{CC} , I _{OUT} =0			4			80	μA

■ DYNAMIC CHARACTERISTICS (Unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		T _A =25°C			T _A =-40°C~+125°C			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
Maximum Clock Frequency	f _{max}	V _{CC} =3.3±0.3V	C _L =15pF	80	120		50			MHz
			C _L =50pF	55	105		30			MHz
		V _{CC} =5±0.5V	C _L =15pF	135	170		90			MHz
			C _L =50pF	95	140		70			MHz
Propagation delay from input RCLK to output Q _A -Q _H	t _{PLH}	V _{CC} =3.3±0.3V	C _L =15pF		8	13			16	ns
			C _L =50pF		10	16			19	ns
		V _{CC} =5±0.5V	C _L =15pF		5	9			11	ns
			C _L =50pF		6.5	11			13	ns
	t _{PHL}	V _{CC} =3.3±0.3V	C _L =15pF		8	13			16	ns
			C _L =50pF		10	16			19	ns
		V _{CC} =5±0.5V	C _L =15pF		5	9			11	ns
			C _L =50pF		6.5	11			13	ns
Propagation delay from input SRCLK to output QH'	t _{PLH}	V _{CC} =3.3±0.3V	C _L =15pF		6.6	13			16.5	ns
			C _L =50pF		9.2	16.5			20.1	ns
		V _{CC} =5±0.5V	C _L =15pF		4.5	8.2			10.5	ns
			C _L =50pF		8	11			13	ns
	t _{PHL}	V _{CC} =3.3±0.3V	C _L =15pF		6.6	13			16.5	ns
			C _L =50pF		9.2	16.5			20.1	ns
		V _{CC} =5±0.5V	C _L =15pF		4.5	8.2			10.5	ns
			C _L =50pF		8	11			13	ns
Propagation delay from input SRCLR to output QH'	t _{PHL}	V _{CC} =3.3±0.3V	C _L =15pF		6.2	12.8			15	ns
			C _L =50pF		9	16.3			18.7	ns
		V _{CC} =5±0.5V	C _L =15pF		4.5	8			10	ns
			C _L =50pF		6.4	10			12	ns
Propagation delay from input OE to output Q _A -Q _H	t _{PZH}	V _{CC} =3.3±0.3V	C _L =15pF		6	11.5			15	ns
			C _L =50pF		7.8	15			18.5	ns
		V _{CC} =5±0.5V	C _L =15pF		4.3	8.6			11	ns
			C _L =50pF		5.7	10.6			13	ns
	t _{PZL}	V _{CC} =3.3±0.3V	C _L =15pF		7.8	11.5			15.0	ns
			C _L =50pF		9.6	15			18.5	ns
		V _{CC} =5±0.5V	C _L =15pF		5.4	8.6			11	ns
			C _L =50pF		6.8	10.6			13	ns
Propagation delay from input OE to output Q _A -Q _H	t _{PHZ}	V _{CC} =3.3±0.3V	C _L =50pF		8.1	15.7			17.5	ns
		V _{CC} =5±0.5V			3.5	10.3			12	ns
	V _{CC} =3.3±0.3V	t _{PLZ}			9.3	15.7			17.5	ns
		V _{CC} =5±0.5V			3.4	10.3			12	ns

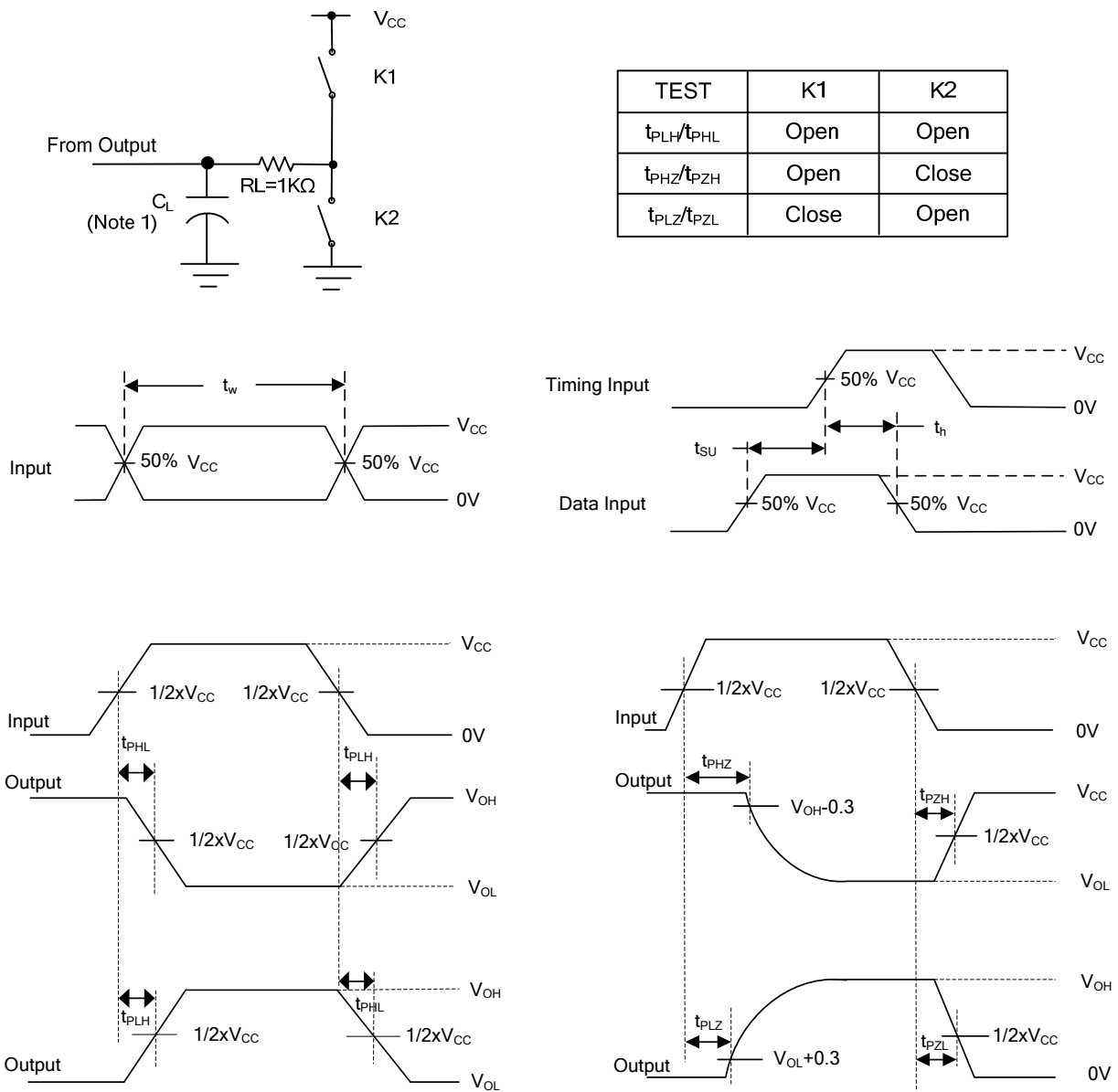
■ TIMING REQUIREMENTS (Unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	T _A =25°C			T _A =-40°C~+125°C			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
Pulse duration, SRCLK high or low	t _w	V _{CC} =3.3±0.3V	5			5			ns
		V _{CC} =5±0.5V	5			5			ns
Pulse duration, RCLK high or low		V _{CC} =3.3±0.3V	5			5			ns
		V _{CC} =5±0.5V	5			5			ns
Pulse duration, $\overline{\text{SRCLR}}$ low		V _{CC} =3.3±0.3V	5			5			ns
		V _{CC} =5±0.5V	5			5			ns
Setup Time, SER before SRCLK↑	t _{su}	V _{CC} =3.3±0.3V	3.5			3.5			ns
		V _{CC} =5±0.5V	3			3			ns
Setup Time, SRCLK↑ before RCLK↑		V _{CC} =3.3±0.3V	8			8			ns
		V _{CC} =5±0.5V	5			5			ns
Setup Time, $\overline{\text{SRCLR}}$ low before RCLK↑		V _{CC} =3.3±0.3V	8			8			ns
		V _{CC} =5±0.5V	5			5			ns
Setup Time, $\overline{\text{SRCLR}}$ high (inactive) before SRCLK↑		V _{CC} =3.3±0.3V	3			3			ns
		V _{CC} =5±0.5V	2.5			2.5			ns
Hold Time, SER after SRCLK↑	t _h	V _{CC} =3.3±0.3V	1.5			1.5			ns
		V _{CC} =5±0.5V	2			2			ns

■ OPERATING CHARACTERISTICS (V_{CC}=5V, T_A=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Input Capacitance	C _{IN}	V _{CC} =5V, V _{IN} =V _{CC} or GND		3	10	
Output Capacitance	C _{OUT}	V _{CC} =5V, V _{OUT} =V _{CC} or GND		5.5		
Power Dissipation Capacitance	C _{PD}	No load, f=1MHz		25.2		pF

■ TEST CIRCUIT AND WAVEFORMS



- Note: 1. C_L includes probe and jig capacitance.
 2. All input pulses are supplied by generators having the following characteristics:
 PRR ≤ 1 MHZ, $Z_O=50\Omega$, $t_r \leq 3$ ns, $t_f \leq 3$ ns.
 3. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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